

# 3D Packaging and Integration Global Technical Committee Japan TC Chapter Meeting

Japan Standards Winter Meetings 2024
Friday, January 26, 2024,
SEMI Japan, Tokyo Japan/ Official Virtual TC Chapter Meeting(Hybrid)
15:00-17:00 JST

## **AGENDA**

#### 1 Welcome / Call to Order

- 1.1 Introductions
- 1.2 Meeting Reminders (Membership Requirement, Antitrust and Intellectual Property Reminders, Effective Meeting Guidelines)
- 1.3 Agenda Review

## 2 Review of Previous Meeting of 3D Packaging & Integration Japan TC Chapter

#### 3 Liaison Report

- 3.1 NA TC Chapter
- 3.2 Taiwan TC Chapter

#### 4 Staff Report

#### 5 Ballot Review

None

## 6 Task Force & Study Group Reports

- 6.1 GCS
- 6.2 3D Packaging & Integration 5 Year Review Task Force
- 6.3 3DS IC Bonded Layer Inspection Metrology Task Force
- 6.4 Panel Level Packaging (PLP) Glass Carrier Task Force
- 6.5 3D Packaging & Integration Steering Group

# 7 Old Business

- 7.1 Project Period Review
- 7.2 5 Year Review Check



## 8 New Business

8.1 Proposal of New Activity

# 9 Action Item Review

- 9.1 Open Action Items
- 9.2 New Action Items
- 10 Next Meeting and Adjournment